504023765 09/27/2016

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4070424

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|-------------------|----------------|
| MOU-SHIUNG LIN | 02/07/2002 |
| JIN-YUAN LEE | 02/07/2002 |
| CHING-CHENG HUANG | 02/07/2002 |

RECEIVING PARTY DATA

| Name: | MEGIC CORPORATION |
|-----------------|---|
| Street Address: | 21, R&D 1ST. RD., SCIENCE-BASED INDUSTRIAL PARK |
| City: | HSINCHU |
| State/Country: | TAIWAN |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 12032707 |

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email:c_sascha@qualcomm.comCorrespondent Name:QUALCOMM INCORPORATEDAddress Line 1:5775 MOREHOUSE DRIVEAddress Line 4:SAN DIEGO, CALIFORNIA 92121

| NAME OF SUBMITTER: | SASCHA KOURIS | |
|--------------------|-----------------|--|
| SIGNATURE: | /Sascha Kouris/ | |
| DATE SIGNED: | 09/27/2016 | |

Total Attachments: 2

source=0128270091#page1.tif source=0128270091#page2.tif

PATENT 504023765 REEL: 039865 FRAME: 0609

ASSIGNMENT

WHEREAS, 1. Mou-Shiung Lin

3. Ching-Cheng Huang

2. Jin-Yuan Lee

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: CHIP STRUCTURE AND PROCESS FOR FORMING THE SAME

[] Filed:

Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Megic Corporation

of 21, R&D 1st Rd., Science-Based Industrial Park Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

-1-

ASSIGNMENT CONTINUED

| IN TESTIMONY WHEREOF, Assignor has/have signed | ed his/her/their name(s) on the date(s) | | | |
|---|---|--|--|--|
| indicated. | | | | |
| Signature J. | 2/7/2002 Date | | | |
| Sole or First Joint Inventor: Mou-Shiung Lin | | | | |
| Jin Tuan De | >/n '5x | | | |
| Signature | Date | | | |
| Second Joint Inventor (if any): Jin-Yuan Lee | | | | |
| Signature Third Joint Inventor (if any): Ching-Cheng Huang | 2/2 - 200 2 Date | | | |
| | | | | |

RECORDED: 04/15/2002 RECORDED: 09/27/2016 PATENT REEL: 012847 ENAME: 0093 REEL: 039865 FRAME: 0611